

# OPTIGA™ Trust M2 ID2

**Product Version: V2**

## About this document

### Scope and purpose

This document specifies the Release Notes for OPTIGA™ Trust M2 ID2 solution.

### Intended audience

This document addresses the audience: customers, solution providers and system integrators.

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**Revision History**

Page	Subjects (major changes since last revision)
5	Engineering Sample Release of OPTIGA™ Trust M2 ID2 v2.00.2473 and its corresponding host libraries.

## 1 Product Version Overview

### 1.1 Release versions

The Release versions defined in the below table is the overall version of OPTIGA™ Trust M2 ID2 which includes the OPTIGA™ Trust M2 ID2 Host library package and OPTIGA™ Trust M2 ID2 security chip version.

Release Version	Build Date	Description
v2.00.2473	2020-06-30	Engineering Sample Release of OPTIGA™ Trust M2 ID2 and its corresponding host libraries

### 1.2 Versioning Scheme

#### 1. Product Version:

It defines the version of the product. (Example: OPTIGA™ Trust M2 ID2 **V2, V3 etc...**)

#### 2. Release version:

Defines the revision of the product released with encoding scheme **Major, Minor, and Build** number.

**Example** – v2.00.2473 (Major version : 2, Minor version : 00, Build version : 2473)

2.1. **Major version** - It depicts the major changes/revisions of the product. Early engineering sample releases will always have the release major version as zero. (Example - vx.yy.zzzz)

2.2. **Minor version** - It changes with releases or/and significant changes in the product. (Example - vx.yy.zzzz)

2.3. **Build version** – It increments based on each change/release of the product. (Example - vx.yy.zzzz)

**Note:** Every release will have an OPTIGA™ security chip version [5], which defines the version of the software loaded on the OPTIGA™ security chip.

OPTIGA™ Trust M2 ID2 security chip version will have the same major and minor version numbers of that particular release version. But the build number of OPTIGA™ Trust M2 ID2 security chip version might be different from the overall release version.

Example:

Release Version : v2.00.2473 (Major version : 2, Minor version : 00, Build version : 2473)  
Security chip version : v2.00.2440 (Major version : 2, Minor version : 00, Build version : 2440)

## **2 Engineering Sample Release v2.00.2473**

### **2.1 Product Description**

OPTIGA™ Trust M2 ID2 v2.00.2473 is an Embedded Security Solution covering use cases to protect the authenticity, integrity and confidentiality of your device: mutual authentication, secure communication, data storage protection, cryptographic toolbox functionalities and lifecycle management for connected devices.

### **2.2 Scope of Release**

OPTIGA™ Trust M2 ID2 v2.00.2473 is released as Engineering Sample Release. The Product is qualified by Infineon with complete documentation describing all features as stated below.

### **2.3 Contents of the Evaluation Kit**

1. OPTIGA™ Trust M2 ID2 security chip with software build v2.00.2440
2. Package containing following Software and Documentation
  - 2.1. binaries
    - 2.1.1.Examples for XMC4800 IOT Connectivity kit
  - 2.2. certificates
    - 2.2.1.Contains OPTIGA™ Trust M2 ID2 certificate for execution of use cases
  - 2.3. documents
    - 2.3.1.OPTIGA™ Trust M2 ID2 Datasheet v2.00
    - 2.3.2.Infineon I2C Protocol v2.02
    - 2.3.3.OPTIGA™ Trust M2 ID2 Solution Reference Manual v2.00
    - 2.3.4.OPTIGA™ Trust M2 ID2 Release Notes v2.00
    - 2.3.5.OPTIGA™ Trust M2 ID2 Host Library Documentation
    - 2.3.6.OPTIGA™ Trust M2 ID2 Getting Started Guide v2.00
    - 2.3.7.OPTIGA™ Trust M2 ID2 License Information
  - 2.4. examples
    - 2.4.1.integration
      - 2.4.1.1. alios irot\_hal integration example file
    - 2.4.2.optiga
      - 2.4.2.1. Example files for OPTIGA™ host library APIs
    - 2.4.3.tools

2.4.3.1. Tool to generate protected update data set for the data objects, key set for key objects and metadata set for data/key objects (used for optiga\_util\_protected\_update API example).

## 2.5. externals

2.5.1. Directory for 3<sup>rd</sup> party libraries (e.g. mbed TLS) and OPTIGA™ specific irot hal file.

## 2.6. optiga

2.6.1. OPTIGA™ host library with source and header files

## 2.7. pal

2.7.1. Platform specific implementation for XMC4800 IoT Connectivity Kit

## 2.8. projects

2.8.1. DAVE™ Eclipse project for XMC4800 IoT Connectivity Kit

## 3. Hardware

3.1. XMC4800 IoT Connectivity Kit

3.2. Shield2Go with OPTIGA™ Trust M2 ID2 security chip

3.3. My IoT Adapter

## 4. Open Source Software – subject to separate licensing terms as below

4.1. Applicable for XMC4800 IoT Connectivity Kit

4.1.1. mbed TLS v2.16.0 crypto library (<https://tls.mbed.org/download>)

4.1.2. LUFA USB stack (<https://www.lufa-lib.org>)

## 2.4 Features

### 1. OPTIGA™ Trust M2 ID2 Security Chip Software

- a. Infineon I2C protocol v2.02 based communication with Shielded Connection support.
- b. Configurable protected data storage.
- c. Life cycle management.
- d. Crypto ToolBox commands with
  - i. RSA 1024/2048 (Sign, Verify, Key generation, Encrypt, Decrypt, Pre-master secret generation for RSA Key exchange (reference TLS V1.2))
  - ii. Symmetric encryption and decryption using AES-128/192/256 (ECB, CBC, CBC-MAC, CMAC) and HMAC SHA256/384/512.
  - iii. KeyDerivation using HKDF SHA256/384/512
- e. Hibernate and restore support.
- f. Integrity and confidentiality protected update of data, metadata and key objects
- g. Boot phase flag(Global and Application security states) based access to protected keys and data
- h. HMAC verification with authorization reference states.
- i. Configurable security monitor.

## 2. OPTIGA™ Trust M2 ID2 Host Software

- a. Support for XMC4800 IoT Connectivity Kit added.
- b. DAVE Eclipse project added to release package. This project can be used for compilation and debugging.
- c. Optiga Crypt Library (Crypto Toolbox command APIs)
- d. Optiga Util Library (Open/Close Application, Read/Write and Protected Update command APIs)
- e. Infineon I2C protocol v2.02 based communication with Shielded Connection support.
- f. AliOS irot HAL integration support.
- g. Tool to generate CBOR based manifest and payload fragments for optiga\_util\_protected\_update API example.

## 2.5 Fixes

None

## 2.6 Enhancements

None

## 2.7 Known Issues

1. Disconnecting the power (VDD pin) of the Host MCU during the communication with OPTIGA™ Trust M2 ID2 and re-establishing the connection might end up in Infineon I2C protocol stack non responsive state due to the low level driver issue observed.

## 2.8 Limitations

1. The maximum number of OPTIGA™ crypt instances which would be based on session is limited to 4 in parallel.
2. Third-party libraries such as mbed TLS might invoke memory allocation functions during optiga comms protection (shielded connection) operations (pal\_crypt). There could be collision during memory allocation, if a create API from service layer is invoked at the same time.
3. OPTIGA™ is a singleton resource. The number of instances that can run in parallel is limited to 6 (1 active instance and 5 instances will be queued up internally). To increase the maximum number of parallel instances, re-configure the macro OPTIGA\_CMD\_MAX\_REGISTRATIONS (minimum value is 1) in optiga\_lib\_config.h.
4. As the RSA key generation can go beyond 50 seconds, the default timeout of ifx i2c protocol (TL\_MAX\_EXIT\_TIMEOUT) is set to 180 seconds. Otherwise, 10 seconds is sufficient.

## 2.9 Environment

None

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**Edition 2020-06-30**

**Published by**

**Infineon Technologies AG**

**81726 Munich, Germany**

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